Octal D-type flip-flop with reset; positive-edge triggerRev. 1 — 19 June 2013Product data sheet

### 1. General description

The 74HC273-Q100; 74HCT273-Q100 is an octal positive-edge triggered D-type flip-flop. The device features clock (CP) and master reset ( $\overline{MR}$ ) inputs. The outputs Qn assume the state of their corresponding Dn inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (CP) transition. A LOW on  $\overline{MR}$  forces the outputs LOW independently of clock and data inputs. Inputs include clamp diodes which enable the use of current limiting resistors to interface inputs to voltages in excess of V<sub>CC</sub>.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
   Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Input levels:
  - For 74HC273-Q100: CMOS level
  - For 74HCT273-Q100: TTL level
- Common clock and master reset
- Eight positive edge-triggered D-type flip-flops
- Complies with JEDEC standard no. 7A
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V.
- Multiple package options

### 3. Ordering information

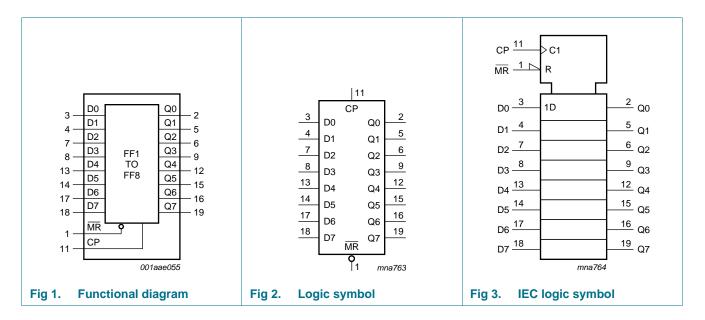
#### Table 1. Ordering information

Type number	Package									
	Temperature range	Name	Description	Version						
74HC273D-Q100	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width	SOT163-1						
74HCT273D-Q100			7.5 mm							
74HC273PW-Q100	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1						
74HCT273PW-Q100			body width 4.4 mm							
74HC273BQ-Q100	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced	SOT764-1						
74HCT273BQ-Q100			very thin quad flat package; no leads; 20 terminals; body 2.5 $\times$ 4.5 $\times$ 0.85 mm							

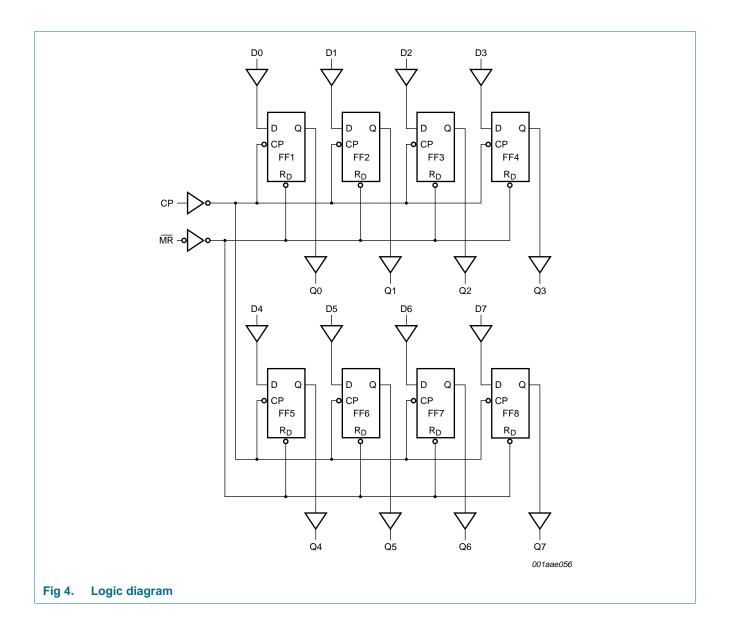


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## 4. Functional diagram

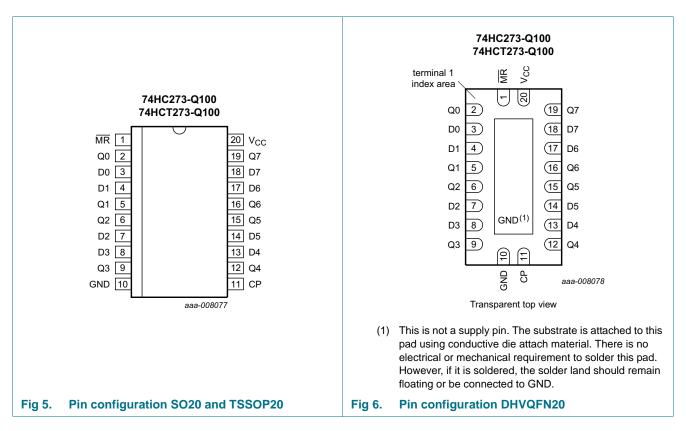


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### 5. Pinning information



### 5.2 Pin description

Table 2.         Pin description		
Symbol	Pin	Description
MR	1	master reset input (active LOW)
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	2, 5, 6, 9, 12, 15, 16, 19	flip-flop output
D0, D1, D2, D3, D4, D5, D6, D7	3, 4, 7, 8, 13, 14, 17, 18	data input
GND	10	ground (0 V)
СР	11	clock input (LOW-to-HIGH, edge-triggered)
V <sub>CC</sub>	20	supply voltage

## 5.1 Pinning

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### 6. Functional description

#### Table 3.Function table<sup>[1]</sup>

Operating modes	Inputs		Outputs	
	MR	Dn	Qn	
reset (clear)	L	Х	Х	L
load "1"	Н	$\uparrow$	h	Н
load "0"	Н	↑	I	L

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

X = don't care;

 $\uparrow$  = LOW-to-HIGH clock transition.

## 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[2] _	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO20 package: above 70 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K. For TSSOP20 package: above 60 °C the value of P<sub>tot</sub> derates linearly with 5.5 mW/K. For DHVQFN20 package: P<sub>tot</sub> derates linearly with 4.5 mW/K above 60 °C.

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## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	I Parameter Conditions		74HC273-Q100			74HCT273-Q100			Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	$V_{CC}$	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 ℃	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC27	3-Q100								1	
VIH	HIGH-level	$V_{CC} = 2.0 V$	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	3.15	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	4.2	-	V
VIL	LOW-level	$V_{CC} = 2.0 V$	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	-	1.35	V
	$V_{CC} = 6.0 V$	-	2.8	1.8	-	1.8	-	1.8	V	
V <sub>OH</sub> HIGH-level		$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O}$ = -20 $\mu$ A; $V_{CC}$ = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O}$ = –20 $\mu A; V_{CC}$ = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O}$ = –20 $\mu A; V_{CC}$ = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O}$ = –5.2 mA; $V_{CC}$ = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \ \mu\text{A}; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1	-	±1	μA
I <sub>CC</sub>	supply current		-	-	8.0	-	80	-	160	μΑ

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#### Octal D-type flip-flop with reset; positive-edge trigger

#### Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	• +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
Cı	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT2	73-Q100									
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
VIL	LOW-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	$I_O$ = 20 $\mu\text{A};V_{CC}$ = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		$I_{O}$ = 5.2 mA; $V_{CC}$ = 5.5 V	-	0.15	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1	-	±1	μA
I <sub>CC</sub>	supply current		-	-	8.0	-	80	-	160	μA
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V								
		MR input	-	100	360	-	450	-	490	μΑ
		CP input	-	175	630	-	787.5	-	857.5	μΑ
		Dn input	-	15	54	-	67.5	-	73.5	μΑ
CI	input capacitance		-	3.5	-	-	-	-	-	pF

## **10. Dynamic characteristics**

#### Table 7. Dynamic characteristics

GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit, see Figure 10

Symbo	ol Parameter	Conditions		25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC2	73-Q100									
t <sub>pd</sub>	propagation	CP to Qn; see Figure 7	1							
	delay	$V_{CC} = 2.0 V$	-	41	150	-	185	-	225	ns
		$V_{CC} = 4.5 V$	-	15	30	-	37	-	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	15	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$	-	13	26	-	31	-	38	ns

### Octal D-type flip-flop with reset; positive-edge trigger

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
PHL	HIGH to LOW	MR to Qn; see Figure 8						I		
	propagation	$V_{CC} = 2.0 V$	-	44	150	-	185	-	225	ns
	delay	$V_{CC} = 4.5 V$	-	16	30	-	37	-	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	15	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$	-	14	26	-	31	-	38	ns
t	transition time	Qn output; see Figure 7	1							
		V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		$V_{CC} = 4.5 V$	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	15	-	19	ns
W	pulse width	CP input HIGH or LOW; see <u>Figure 7</u>								
		$V_{CC} = 2.0 V$	80	14	-	100	-	120	-	ns
		$V_{CC} = 4.5 V$	16	5	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	4	-	17	-	20	-	ns
		MR input LOW; see <u>Figure 8</u>								
		$V_{CC} = 2.0 V$	60	17	-	75	-	90	-	ns
		$V_{CC} = 4.5 V$	12	6	-	15	-	18	-	ns
		$V_{CC} = 6.0 V$	10	5	-	13	-	15	-	ns
rec	recovery time	MR to CP; see Figure 8								
		$V_{CC} = 2.0 V$	50	-6	-	65	-	75	-	ns
		$V_{CC} = 4.5 V$	10	-2	-	13	-	15	-	ns
		$V_{CC} = 6.0 V$	9	-2	-	11	-	13	-	ns
su	set-up time	Dn to CP; see Figure 9								
		$V_{CC} = 2.0 V$	60	11	-	75	-	90	-	ns
		$V_{CC} = 4.5 V$	12	4	-	15	-	18	-	ns
		$V_{CC} = 6.0 V$	10	3	-	13	-	15	-	ns
h	hold time	Dn to CP; see Figure 9								
		$V_{CC} = 2.0 V$	3	-6	-	3	-	3	-	ns
		$V_{CC} = 4.5 V$	3	-2	-	3	-	3	-	ns
		$V_{CC} = 6.0 V$	3	-2	-	3	-	3	-	ns
max	maximum	CP input; see Figure 7								
	frequency	$V_{CC} = 2.0 V$	6	20.6	-	4.8	-	4	-	MH
		$V_{CC} = 4.5 V$	30	103	-	24	-	20	-	MH
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	66	-	-	-	-	-	MH
		$V_{CC} = 6.0 V$	35	122	-	28	-	24	-	MH
C <sub>PD</sub>	power dissipation capacitance	per package; $V_1 = GND$ to $V_{CC}$	<u>l</u> -	20	-	-	-	-	-	pF

#### Table 7. Dynamic characteristics ... continued

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#### Octal D-type flip-flop with reset; positive-edge trigger

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT27	73-Q100									
t <sub>pd</sub>	propagation	CP to Qn; see Figure 7	1							
	delay	$V_{CC} = 4.5 V$	-	16	30	-	38	-	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	15	-	-	-	-	-	ns
t <sub>PHL</sub>	HIGH to LOW	MR to Qn; see Figure 8								
	propagation	$V_{CC} = 4.5 V$	-	23	34	-	43	-	51	ns
	delay	$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
t <sub>t</sub>	transition time	Qn output; see Figure 7	2]							
		$V_{CC} = 4.5 V$	-	7	15	-	19	-	22	ns
t <sub>W</sub>	pulse width	CP input; see Figure 7								
		$V_{CC} = 4.5 V$	16	9	-	20	-	24	-	ns
		MR input LOW; see <u>Figure 8</u>								
		$V_{CC} = 4.5 V$	16	8	-	20	-	24	-	ns
t <sub>rec</sub>	recovery time	MR to CP; see Figure 8								
		$V_{CC} = 4.5 V$	10	-2	-	13	-	15	-	ns
t <sub>su</sub>	set-up time	Dn to CP; see Figure 9								
		$V_{CC} = 4.5 V$	12	5	-	15	-	18	-	ns
t <sub>h</sub>	hold time	Dn to CP; see Figure 9								
		$V_{CC} = 4.5 V$	3	-4	-	3	-	3	-	ns
f <sub>max</sub>	maximum	CP input; see Figure 7								
	frequency	$V_{CC} = 4.5 V$	30	56	-	24	-	20	-	MHz
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	36	-	-	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance	per package; $\underline{I}$ V <sub>I</sub> = GND to V <sub>CC</sub> - 1.5 V	<u>3]</u> -	23	-	-	-	-	-	pF

#### Table 7. Dynamic characteristics ...continued

GND (ground = 0 V);  $C_1 = 50 \text{ pF}$  unless otherwise specified; for test circuit, see Figure 10

[1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .

- [2]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).
  - $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

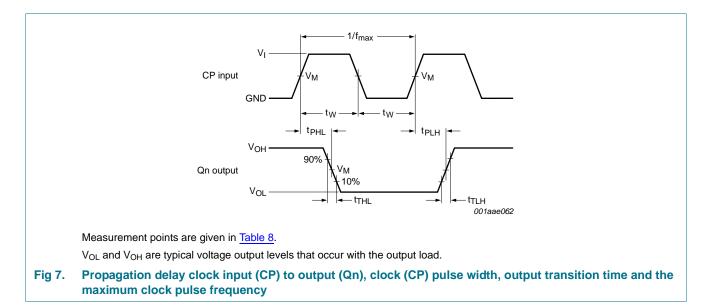
- $f_o$  = output frequency in MHz;
- $\Sigma (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs;
- $C_L$  = output load capacitance in pF;

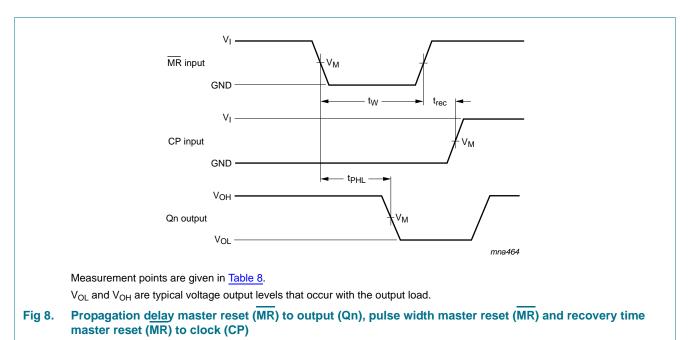
 $V_{CC}$  = supply voltage in V.

 $f_i$  = input frequency in MHz;

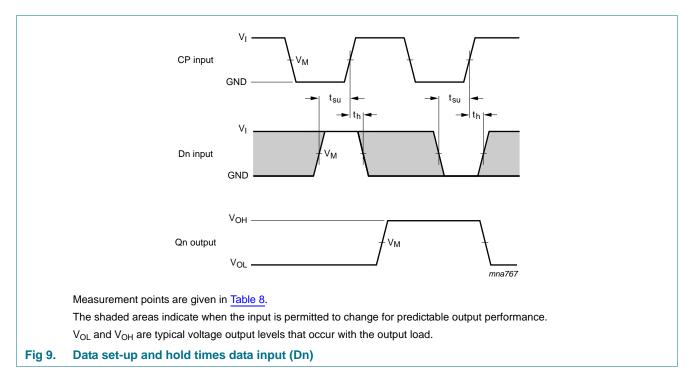
Octal D-type flip-flop with reset; positive-edge trigger

### 11. Waveforms





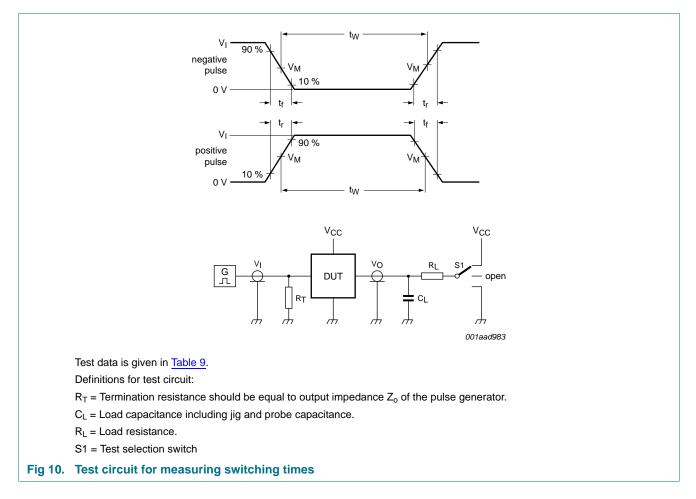
Octal D-type flip-flop with reset; positive-edge trigger



#### Table 8.Measurement points

Туре	Input	Output	
	V <sub>I</sub>	V <sub>M</sub>	V <sub>M</sub>
74HC273-Q100	V <sub>CC</sub>	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT273-Q100	3 V	1.3 V	1.3 V

Octal D-type flip-flop with reset; positive-edge trigger

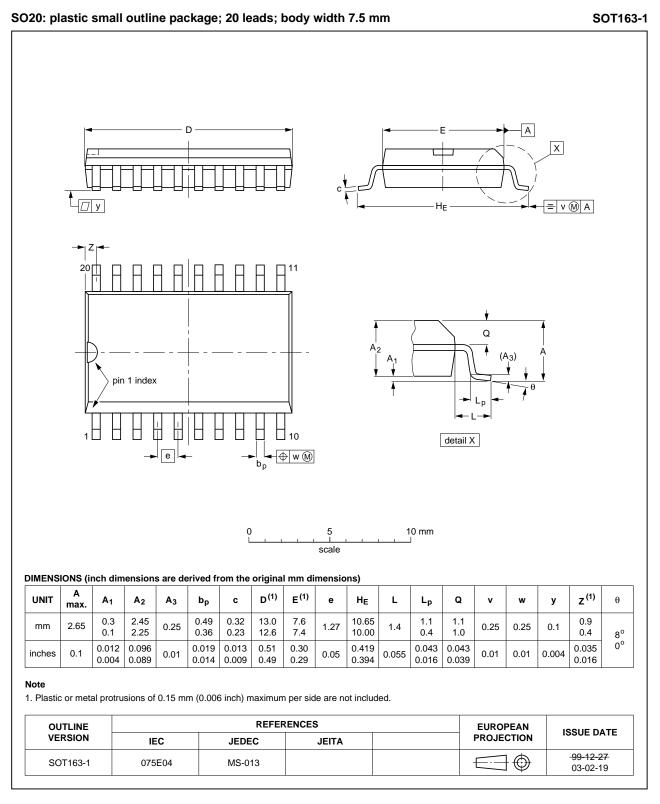


#### Table 9.Test data

Туре	Input		Load	S1 position	
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>
74HC273-Q100	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT273-Q100	3 V	6 ns	15 pF, 50 pF	1 kΩ	open

Octal D-type flip-flop with reset; positive-edge trigger

### 12. Package outline

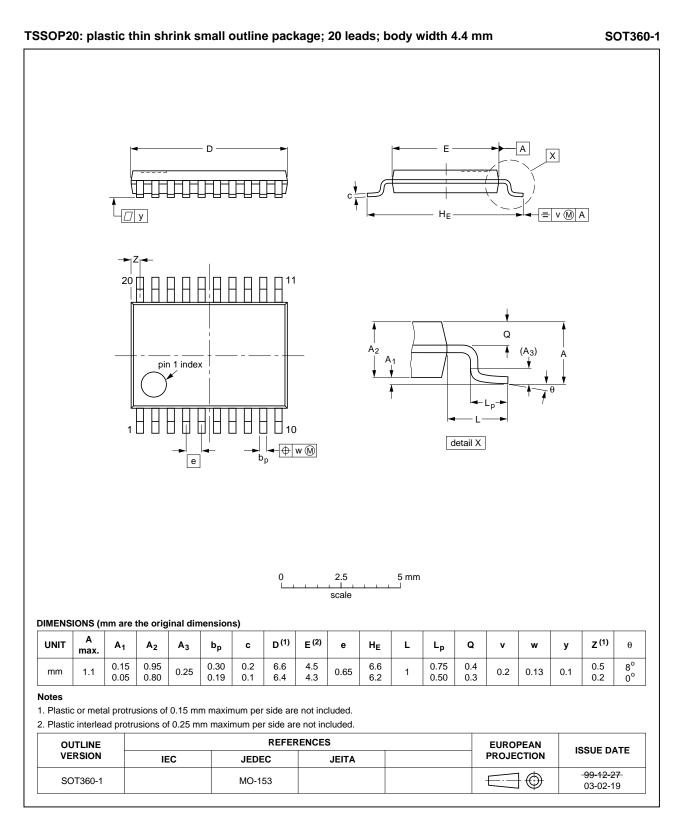


#### Fig 11. Package outline SOT163-1 (SO20)

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Octal D-type flip-flop with reset; positive-edge trigger

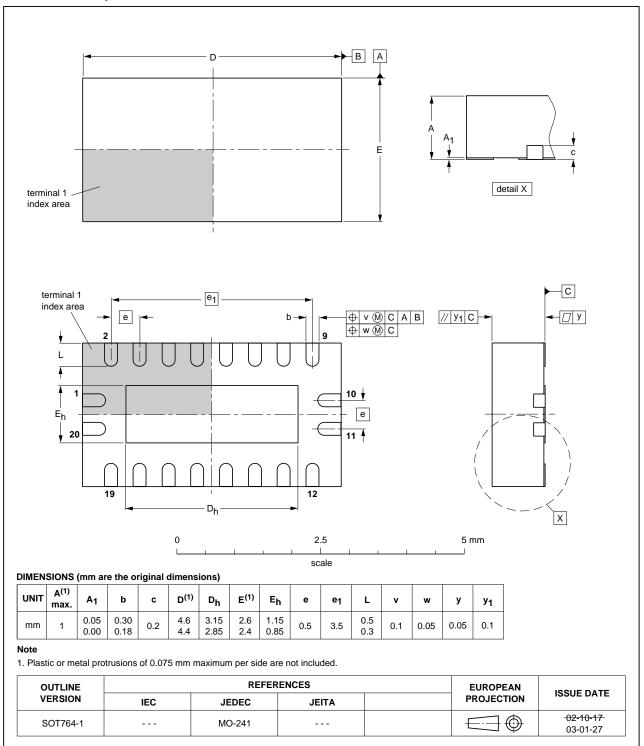


#### Fig 12. Package outline SOT360-1 (TSSOP20)

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74HC\_HCT273\_Q100

Octal D-type flip-flop with reset; positive-edge trigger



DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

#### Fig 13. Package outline SOT764-1 (DHVQFN20)

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74HC\_HCT273\_Q100

Octal D-type flip-flop with reset; positive-edge trigger

## **13. Abbreviations**

Table 10.	able 10. Abbreviations		
Acronym	Description		
CMOS	Complementary Metal-Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MIL	Military		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

## 14. Revision history

Table 11. Revision histor	Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC_HCT273_Q100 v.1	20130619	Product data sheet	-	-			

Octal D-type flip-flop with reset; positive-edge trigger

## 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition	
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.	
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.	
Product [short] data sheet	Production	This document contains the product specification.	

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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Octal D-type flip-flop with reset; positive-edge trigger

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### **NXP Semiconductors**

# 74HC273-Q100; 74HCT273-Q100

Octal D-type flip-flop with reset; positive-edge trigger

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Date of release: 19 June 2013 Document identifier: 74HC\_HCT273\_Q100 This datasheet has been downloaded from:

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